LT1207



Dual 250mA/60MHz Current Feedback Amplifier

FEATURES

- 250mA Minimum Output Drive Current
- 60MHz Bandwidth, $A_V = 2$, $R_L = 100\Omega$
- 900V/ μ s Slew Rate, $A_V = 2$, $R_L = 50\Omega$
- 0.02% Differential Gain, $A_V = 2$, $R_L = 30\Omega$
- 0.17° Differential Phase, $A_V = 2$, $R_L = 30\Omega$
- High Input Impedance: 10MΩ
- Shutdown Mode: I_S < 200µA per Amplifier</p>
- Stable with $C_L = 10,000 pF$

APPLICATIONS

- ADSL/HDSL Drivers
- Video Amplifiers
- Cable Drivers
- RGB Amplifiers
- Test Equipment Amplifiers
- Buffers

DESCRIPTION

The LT[®]1207 is a dual version of the LT1206 high speed current feedback amplifier. Like the LT1206, each CFA in the dual has excellent video characteristics: 60MHz bandwidth, 250mA minimum output drive current, 400V/µs minimum slew rate, low differential gain (0.02% typ) and low differential phase (0.17° typ). The LT1207 includes a pin for an optional compensation network which stabilizes the amplifier for heavy capacitive loads. Both amplifiers have thermal and current limit circuits which protect against fault conditions. These capabilities make the LT1207 well suited for driving difficult loads such as cables in video or digital communication systems.

Operation is fully specified from $\pm 5V$ to $\pm 15V$ supplies. Supply current is typically 20mA per amplifier. Two micropower shutdown controls place each amplifier in a high impedance low current mode, dropping supply current to 200µA per amplifier. For reduced bandwidth applications, supply current can be lowered by adding a resistor in series with the Shutdown pin.

The LT1207 is manufactured on Linear Technology's complementary bipolar process and is available in a low thermal resistance 16-lead SO package.

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ABSOLUTE MAXIMUM RATINGS

Supply Voltage	. ±18V
Input Current per Amplifier	±15mA
Output Short-Circuit Duration (Note 1) Cont	tinuous
Specified Temperature Range (Note 2) 0°C t	:o 70°C
Operating Temperature Range40°C t	:o 85°C
Junction Temperature	150°C
Storage Temperature Range65°C to	150°C
Lead Temperature (Soldering, 10 sec)	300°C

PACKAGE/ORDER INFORMATION



Consult factory for Industrial and Military grade parts.

ELECTRICAL CHARACTERISTICS

 V_{CM} = 0, $\pm 5V \leq V_S \leq \pm 15V,$ pulse tested, $V_{SHDN \; A}$ = 0V, $V_{SHDN \; B}$ = 0V, unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
V _{OS}	Input Offset Voltage	T _A = 25°C	•		±3	±10 ±15	mV mV
	Input Offset Voltage Drift				10		μV/°C
I _{IN} +	Noninverting Input Current	T _A = 25°C	•		±2	±5 ±20	μA μA
I _{IN} ⁻	Inverting Input Current	T _A = 25°C	•		±10	±60 ±100	μA μA
en	Input Noise Voltage Density	f = 10kHz, R _F = 1k, R _G = 10Ω, R _S = 0Ω			3.6		nV/√Hz
+i _n	Input Noise Current Density	f = 10kHz, R_F = 1k, R_G = 10Ω, R_S = 10k			2		pA/√Hz
-i _n	Input Noise Current Density	f = 10kHz, R_F = 1k, R_G = 10 Ω , R_S = 10k			30		pA/√Hz
R _{IN}	Input Resistance	$V_{IN} = \pm 12V, V_S = \pm 15V$ $V_{IN} = \pm 2V, V_S = \pm 5V$	•	1.5 0.5	10 5		ΜΩ ΜΩ
C _{IN}	Input Capacitance	$V_{S} = \pm 15V$			2		pF
	Input Voltage Range	$V_{S} = \pm 15V$ $V_{S} = \pm 5V$	•	±12 ±2	±13.5 ±3.5		V V
CMRR	Common Mode Rejection Ratio	$V_{S} = \pm 15V, V_{CM} = \pm 12V$ $V_{S} = \pm 5V, V_{CM} = \pm 2V$	•	55 50	62 60		dB dB
	Inverting Input Current Common Mode Rejection	$V_{S} = \pm 15V, V_{CM} = \pm 12V$ $V_{S} = \pm 5V, V_{CM} = \pm 2V$	•		0.1 0.1	10 10	μΑ/V μΑ/V
PSRR	Power Supply Rejection Ratio	$V_{S} = \pm 5V$ to $\pm 15V$		60	77		dB



ELECTRICAL CHARACTERISTICS

 V_{CM} = 0, $\pm 5V \leq V_S \leq \pm 15V,$ pulse tested, $V_{SHDN \; A}$ = 0V, $V_{SHDN \; B}$ = 0V, unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
	Noninverting Input Current Power Supply Rejection	$V_{S} = \pm 5V$ to $\pm 15V$	•		30	500	nA/V
	Inverting Input Current Power Supply Rejection	$V_{S} = \pm 5V$ to $\pm 15V$	•		0.7	5	μA/V
A _V	Large-Signal Voltage Gain	$V_{S} = \pm 15V, V_{OUT} = \pm 10V, R_{L} = 50\Omega$ $V_{S} = \pm 5V, V_{OUT} = \pm 2V, R_{L} = 25\Omega$	•	55 55	71 68		dB dB
R _{OL}	Transresistance, $\Delta V_{OUT} / \Delta I_{IN}^{-}$	$V_{S} = \pm 15V, V_{OUT} = \pm 10V, R_{L} = 50\Omega$ $V_{S} = \pm 5V, V_{OUT} = \pm 2V, R_{L} = 25\Omega$	•	100 75	260 200		kΩ kΩ
V _{OUT}	Maximum Output Voltage Swing	$V_S = \pm 15 V$, $R_L = 50 \Omega$, $T_A = 25^{\circ} C$		±11.5	±12.5		V
		$V_{S} = \pm 5V, R_{L} = 25\Omega, T_{A} = 25^{\circ}C$	•	±10.0 ±2.5 ±2.0	±3.0		V V V
I _{OUT}	Maximum Output Current	$R_L = 1\Omega$	•	250	500	1200	mA
I _S	Supply Current per Amplifier	$V_S = \pm 15V, V_{SHDN} = 0V, T_A = 25^{\circ}C$	•		20	30 35	mA mA
	Supply Current per Amplifier, R _{SHDN} = 51k (Note 4)	$V_S = \pm 15 V$, $T_A = 25^{\circ}C$			12	17	mA
	Positive Supply Current per Amplifier, Shutdown	$V_{S} = \pm 15V, V_{SHDN A} = 15V, V_{SHDN B} = 15V$	•			200	μA
	Output Leakage Current, Shutdown	$V_{S} = \pm 15V, V_{SHDN} = 15V, V_{OUT} = 0V$	•			10	μA
SR	Slew Rate (Note 5)	$A_V = 2, T_A = 25^{\circ}C$		400	900		V/µs
	Differential Gain (Note 6)	$V_S=\pm 15V,R_F=560\Omega,R_G=560\Omega,R_L=30\Omega$			0.02		%
	Differential Phase (Note 6)	$V_S = \pm 15V, R_F = 560\Omega, R_G = 560\Omega, R_L = 30\Omega$			0.17		DEG
BW	Small-Signal Bandwidth	V_S = $\pm 15V,$ Peaking $\leq 0.5dB$ R_F = R_G = 620 $\Omega,$ R_L = 100 Ω			60		MHz
		$\label{eq:VS} \begin{array}{l} V_S = \pm 15 V, \mbox{ Peaking} \leq 0.5 dB \\ R_F = R_G = 649 \Omega, R_L = 50 \Omega \end{array}$			52		MHz
		$\label{eq:VS} \begin{array}{l} V_S = \pm 15 V, \mbox{ Peaking} \leq 0.5 dB \\ R_F = R_G = 698 \Omega, R_L = 30 \Omega \end{array}$			43		MHz
		$\label{eq:VS} \begin{array}{l} V_S = \pm 15V, \mbox{ Peaking} \leq 0.5dB \\ R_F = R_G = 825\Omega, R_L = 10\Omega \end{array}$			27		MHz

The \bullet denotes specifications which apply for $0^{\circ}C \le T_A \le 70^{\circ}C$. **Note 1:** Applies to short circuits to ground only. A short circuit between the output and either supply may permanently damage the part when operated on supplies greater than $\pm 10V$.

Note 2: Commercial grade parts are designed to operate over the temperature range of -40° C to 85°C but are neither tested nor guaranteed beyond 0°C to 70°C. Industrial grade parts tested over -40° C to 85°C are available on special request. Consult factory.

Note 3: Thermal resistance θ_{JA} varies from 40°C/W to 60°C/W depending upon the amount of PC board metal attached to the device. θ_{JA} is specified for a 2500mm² test board covered with 2oz copper on both sides. **Note 4:** R_{SHDN} is connected between the Shutdown pin and ground. **Note 5:** Slew rate is measured at ±5V on a ±10V output signal while operating on ±15V supplies with R_F = 1.5k, R_G = 1.5k and R_L = 400 Ω . **Note 6:** NTSC composite video with an output level of 2V.



SMALL-SIGNAL BANDWIDTH

 I_S = 20mA per Amplifier Typical, Peaking $\leq 0.1 dB$

Av	RL	R _F	R _G	-3dB BW (MHz)	-0.1dB BW (MHz)			
$V_S = \pm 5V$	$V_{S} = \pm 5V, R_{SHDN} = 0\Omega$							
-1	150	562	562	48	21.4			
	30	649	649	34	17			
	10	732	732	22	12.5			
1	150	619	-	54	22.3			
	30	715	-	36	17.5			
	10	806	-	22.4	11.5			
2	150	576	576	48	20.7			
	30	649	649	35	18.1			
	10	750	750	22.4	11.7			
10	150	442	48.7	40	19.2			
	30	511	56.2	31	16.5			
	10	649	71.5	20	10.2			

 I_S = 10mA per Amplifier Typical, Peaking \leq 0.1dB

Av	RL	R _F	R _G	-3dB BW (MHz)	-0.1dB BW (MHz)			
$V_S = \pm 5V$	$V_{\rm S} = \pm 5V, R_{\rm SHDN} = 10.2k$							
-1	150	576	576	35	17			
	30	681	681	25	12.5			
	10	750	750	16.4	8.7			
1	150	665	_	37	17.5			
	30	768	_	25	12.6			
	10	845	_	16.5	8.2			
2	150	590	590	35	16.8			
	30	681	681	25	13.4			
	10	768	768	16.2	8.1			
10	150	301	33.2	31	15.6			
	30	392	43.2	23	11.9			
	10	499	54.9	15	7.8			

Av	RL	R _F	R _G	-3dB BW (MHz)	-0.1dB BW (MHz)			
V _S = ±15	$s = \pm 15V, R_{SHDN} = 0\Omega$							
-1	150	681	681	50	19.2			
	30	768	768	35	17			
	10	887	887	24	12.3			
1	150	768	-	66	22.4			
	30	909	-	37	17.5			
	10	1k	-	23	12			
2	150	665	665	55	23			
	30	787	787	36	18.5			
	10	931	931	22.5	11.8			
10	150	487	536	44	20.7			
	30	590	64.9	33	17.5			
	10	768	84.5	20.7	10.8			

Av	RL	R _F	R _G	-3dB BW (MHz)	-0.1dB BW (MHz)		
$V_S = \pm 15V, R_{SHDN} = 60.4k$							
-1	150	634	634	41	19.1		
	30	768	768	26.5	14		
	10	866	866	17	9.4		
1	150	768	-	44	18.8		
	30	909	-	28	14.4		
	10	1k	-	16.8	8.3		
2	150	649	649	40	18.5		
	30	787	787	27	14.1		
	10	931	931	16.5	8.1		
10	150	301	33.2	33	15.6		
	30	402	44.2	25	13.3		
	10	590	64.9	15.3	7.4		

I_S = 5mA per Amplifier Typical, Peaking $\leq 0.1 dB$

A _V	RL	R _F	R _G	-3dB BW (MHz)	-0.1dB BW (MHz)	A _V	RL	R _F	R _G	-3dB BW (MHz)	-0.1dB BW (MHz)
$V_S = \pm 5V$	$V_{\rm S} = \pm 5V, R_{\rm SHDN} = 22.1k$					V _S = ±15	V, R _{shdn}	= 121k			
-1	150 30 10	604 715 681	604 715 681	21 14.6 10.5	10.5 7.4 6.0	-1	150 30 10	619 787 825	619 787 825	25 15.8 10.5	12.5 8.5 5.4
1	150 30 10	768 866 825	- - -	20 14.1 9.8	9.6 6.7 5.1	1	150 30 10	845 1k 1k	- - -	23 15.3 10	10.6 7.6 5.2
2	150 30 10	634 750 732	634 750 732	20 14.1 9.6	9.6 7.2 5.1	2	150 30 10	681 845 866	681 845 866	23 15 10	10.2 7.7 5.4
10	150 30 10	100 100 100	11.1 11.1 11.1	16.2 13.4 9.5	5.8 7.0 4.7	10	150 30 10	100 100 100	11.1 11.1 11.1	15.9 13.6 9.6	4.5 6 4.5



TYPICAL PERFORMANCE CHARACTERISTICS







Bandwidth vs Supply Voltage



Bandwidth vs Supply Voltage



Bandwidth and Feedback Resistance vs Capacitive Load for 5dB Peak



Differential Phase vs Supply Voltage



Differential Gain vs Supply Voltage



Spot Noise Voltage and Current vs Frequency





TYPICAL PERFORMANCE CHARACTERISTICS





TYPICAL PERFORMANCE CHARACTERISTICS



3rd Order Intercept vs Frequency



Test Circuit for 3rd Order Intercept



SIMPLIFIED SCHEMATIC



APPLICATIONS INFORMATION

The LT1207 is a dual current feedback amplifier with high output current drive capability. The device is stable with large capacitive loads and can easily supply the high currents required by capacitive loads. The amplifier will drive low impedance loads such as cables with excellent linearity at high frequencies.

Feedback Resistor Selection

The optimum value for the feedback resistors is a function of the operating conditions of the device, the load impedance and the desired flatness of response. The Typical AC Performance tables give the values which result in the highest 0.1dB and 0.5dB bandwidths for various resistive loads and operating conditions. If this level of flatness is not required, a higher bandwidth can be obtained by use of a lower feedback resistor. The characteristic curves of Bandwidth vs Supply Voltage indicate feedback resistors for peaking up to 5dB. These curves use a solid line when the response has less than 0.5dB of peaking and a dashed line when the response has 0.5dB to 5dB of peaking. The curves stop where the response has more than 5dB of peaking.

For resistive loads, the COMP pin should be left open (see section on capacitive loads).

Capacitive Loads

Each amplifier in the LT1207 includes an optional compensation network for driving capacitive loads. This network eliminates most of the output stage peaking associated with capacitive loads, allowing the frequency response to be flattened. Figure 1 shows the effect of the network on a 200pF load. Without the optional compensation, there is a 5dB peak at 40MHz caused by the effect of the capacitance on the output stage. Adding a 0.01μ F bypass capacitor between the output and the COMP pins connects the compensation and completely eliminates the peaking. A lower value feedback resistor can now be used, resulting in a response which is flat to 0.35dB to 30MHz.



APPLICATIONS INFORMATION



Figure 1.

The network has the greatest effect for C_L in the range of OpF to 1000pF. The graph of Maximum Capacitive Load vs Feedback Resistor can be used to select the appropriate value of the feedback resistor. The values shown are for 0.5dB and 5dB peaking at a gain of 2 with no resistive load. This is a worst-case condition, as the amplifier is more stable at higher gains and with some resistive load in parallel with the capacitance. Also shown is the -3dB bandwidth with the suggested feedback resistor vs the load capacitance.

Although the optional compensation works well with capacitive loads, it simply reduces the bandwidth when it is connected with resistive loads. For instance, with a 30Ω load, the bandwidth drops from 55MHz to 35MHz when the compensation is connected. Hence, the compensation was made optional. To disconnect the optional compensation, leave the COMP pin open.

Shutdown/Current Set

If the shutdown feature is not used, the Shutdown pins must be connected to ground or V^- .

Each amplifier has a separate Shutdown pin which can be used to either turn off the amplifier, which reduces the amplifier supply current to less than 200μ A, or to control the supply current in normal operation.

The supply current in each amplifier is controlled by the current flowing out of the Shutdown pin. When the Shutdown pin is open or driven to the positive supply, the amplifier is shut down. In the shutdown mode, the output looks like a 40pF capacitor and the supply current is





Figure 2. Shutdown Interface



Figure 3. Shutdown Operation

For applications where the full bandwidth of the amplifier is not required, the quiescent current may be reduced by connecting a resistor from the Shutdown pin to ground.



APPLICATIONS INFORMATION

The amplifier's supply current will be approximately 40 times the current in the Shutdown pin. The voltage across the resistor in this condition is $V^+ - 3V_{BE}$. For example, a 60k resistor will set the amplifier's supply current to 10mA with $V_S = \pm 15V$.

The photos (Figures 4a and 4b) show the effect of reducing the quiescent supply current on the large-signal response. The quiescent current can be reduced to 5mA in the inverting configuration without much change in response. In noninverting mode, however, the slew rate is reduced as the quiescent current is reduced.



Figure 4a. Large-Signal Response vs I_Q , $A_V = -1$



Figure 4b. Large-Signal Response vs I_Q , $A_V = 2$

Slew Rate

Unlike a traditional op amp, the slew rate of a current feedback amplifier is not independent of the amplifier gain configuration. There are slew rate limitations in both the input stage and the output stage. In the inverting mode, and for higher gains in the noninverting mode, the signal amplitude on the input pins is small and the overall slew rate is that of the output stage. The input stage slew rate is related to the quiescent current and will be reduced as the supply current is reduced. The output slew rate is set by the value of the feedback resistors and the internal capacitance. Larger feedback resistors will reduce the slew rate as will lower supply voltages, similar to the way the bandwidth is reduced. The photos (Figures 5a, 5b and 5c) show the large-signal response of the LT1207 or various gain configurations. The slew rate varies from $860V/\mu$ s for a gain of 1, to $1400V/\mu$ s for a gain of -1.

When the LT1207 is used to drive capacitive loads, the available output current can limit the overall slew rate. In the fastest configuration, the LT1207 is capable of a slew rate of over 1V/ns. The current required to slew a capacitor



Figure 5b. Large-Signal Response, $A_V = -1$



P= 7500

APPLICATIONS INFORMATION

 $R_F = 750\Omega$ $R_I = 50\Omega$

Figure 5c. Large-Signal Response, $A_V = 2$

at this rate is 1mA per picofarad of capacitance, so 10,000pF would require 10A! The photo (Figure 6) shows the large-signal behavior with $C_L = 10,000pF$. The slew rate is about 60V/µs, determined by the current limit of 600mA.



Figure 6. Large-Signal Response, $C_L = 10,000 pF$

Differential Input Signal Swing

The differential input swing is limited to about $\pm 6V$ by an ESD protection device connected between the inputs. In normal operation, the differential voltage between the input pins is small, so this clamp has no effect; however, in the shutdown mode the differential swing can be the same as the input swing. The clamp voltage will then set the maximum allowable input voltage. To allow for some margin, it is recommended that the input signal be less than $\pm 5V$ when the device is shut down.

Capacitance on the Inverting Input

Current feedback amplifiers require resistive feedback from the output to the inverting input for stable operation. Take care to minimize the stray capacitance between the output and the inverting input. Capacitance on the inverting input to ground will cause peaking in the frequency response (and overshoot in the transient response), but it does not degrade the stability of the amplifier.

Power Supplies

The LT1207 will operate from single or split supplies from $\pm 5V$ (10V total) to $\pm 15V$ (30V total). It is not necessary to use equal value split supplies, however the offset voltage and inverting input bias current will change. The offset voltage changes about 500µV per volt of supply mismatch. The inverting bias current can change as much as 5µA per volt of supply mismatch, though typically the change is less than 0.5µA per volt.

Thermal Considerations

Each amplifier in the LT1207 includes a separate thermal shutdown circuit which protects against excessive internal (junction) temperature. If the junction temperature exceeds the protection threshold, the amplifier will begin cycling between normal operation and an off state. The cycling is not harmful to the part. The thermal cycling occurs at a slow rate, typically 10ms to several seconds, which depends on the power dissipation and the thermal time constants of the package and heat sinking. Raising the ambient temperature until the device begins thermal shutdown gives a good indication of how much margin there is in the thermal design.

Heat flows away from the amplifier through the package's copper lead frame. Heat sinking is accomplished by using the heat spreading capabilities of the PC board and its copper traces. Experiments have shown that the heat spreading copper layer does not need to be electrically connected to the tab of the device. The PCB material can be very effective at transmitting heat between the pad area attached to the tab of the device and a ground or power plane layer either inside or on the opposite side of the board. Although the actual thermal resistance of the PCB material is high, the length/area ratio of the thermal



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resistance between the layer is small. Copper board stiffeners and plated through holes can also be used to spread the heat generated by the device.

Table 1 lists thermal resistance for several different board sizes and copper areas. All measurements were taken in still air on 3/32" FR-4 board with 2oz copper. This data can be used as a rough guideline in estimating thermal resistance. The thermal resistance for each application will be affected by thermal interactions with other components as well as board size and shape.

ladie 1. Fused 16-Lead SU Package							
COPPER	AREA (2oz)	TOTAL	THERMAL RESISTANCE				
TOPSIDE	BACKSIDE	COPPER AREA	(JUNCTION-TO-AMBIENT)				
2500 sq. mm	2500 sq. mm	5000 sq. mm	40°C/W				
1000 sq. mm	2500 sq. mm	3500 sq. mm	46°C/W				
600 sq. mm	2500 sq. mm	3100 sq. mm	48°C/W				
180 sq. mm	2500 sq. mm	2680 sq. mm	49°C/W				
180 sq. mm	1000 sq. mm	1180 sq. mm	56°C/W				
180 sq. mm	600 sq. mm	780 sq. mm	58°C/W				
180 sq. mm	300 sq. mm	480 sq. mm	59°C/W				
180 sq. mm	100 sq. mm	280 sq. mm	60°C/W				
180 sq. mm	0 sq. mm	180 sq. mm	61°C/W				





Figure 7. Thermal Resistance vs Total Copper Area (Top + Bottom)

Calculating Junction Temperature

The junction temperature can be calculated from the equation:

$$T_{J} = (P_{D})(\theta_{JA}) + T_{A}$$

 T_J = Junction Temperature T_A = Ambient Temperature

 P_D = Device Dissipation

 θ_{JA} = Thermal Resistance (Junction-to-Ambient)

As an example, calculate the junction temperature for the circuit in Figure 8 assuming a 70°C ambient temperature.

The device dissipation can be found by measuring the supply currents, calculating the total dissipation and then subtracting the dissipation in the load and feedback network.



Figure 8. Thermal Calculation Example

The dissipation for each amplifier is:

 $P_D = (37.5 \text{mA})(30 \text{V}) - (12 \text{V})^2 / (1 \text{k} \text{II} \text{k}) = 0.837 \text{W}$

The total dissipation is $P_D = 1.674W$. When a 2500 sq mm PC board with 2oz copper on top and bottom is used, the thermal resistance is 40°C/W. The junction temperature T_J is:

 $T_J = (1.674W)(40^{\circ}C/W) + 70^{\circ}C = 137^{\circ}C$

The maximum junction temperature for the LT1207 is 150° C, so the heat sinking capability of the board is adequate for the application.

If the copper area on the PC board is reduced to 280mm² the thermal resistance increases to 60°C/W and the junction temperature becomes:

 $T_J = (1.674W)(60^{\circ}C/W) + 70^{\circ}C = 170^{\circ}C$

Which is above the maximum junction temperature indicating that the heat sinking capability of the board is inadequate and should be increased.



TYPICAL APPLICATIONS



Gain of Eleven High Current Amplifier

Gain of Ten Buffered Line Driver



TYPICAL APPLICATIONS

CMOS Logic to Shutdown Interface



Distribution Amplifier



Buffer $A_V = 1$



Differential Output Driver



Differential Input—Differential Output Power Amplifier (A_V = 4)





TYPICAL APPLICATIONS



Paralleling Both CFAs for Guaranteed 500mA Output Drive Current

PACKAGE DESCRIPTION Dimensions in inches (millimeters) unless otherwise noted.



S Package 16-Lead Plastic Small Outline (Narrow 0.150) (LTC DWG # 05-08-1610)

*DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAI FLASH SHALL NOT EXCEED 0.010" (0.254mm) PER SIDE



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TYPICAL APPLICATION



CCD Clock Driver. Two 3rd Order Gaussian Filters Produce Clean CCD Clock Signals

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LT1206	Single 250mA/60MHz Current Feedback Amplifier	Single Version of LT1207, 900V/ μ s Slew Rate, 0.02% Differential Gain, 0.17° Differential Phase, with A _V = 2 and R _L = 30 Ω , Stable with C _L = 10,000pF, Shutdown Control Reduces Supply Current to 200 μ A
LT1210	Single 1A/30MHz Current Feedback Amplifier	Higher Output Current Version of LT1206
LT1229/LT1230	Dual/Quad 100MHz Current Feedback Amplifiers	Low Cost CFA for Video Applications, 1000V/ μ s Slew Rate, 30mA Output Drive Current, 0.04% Differential Gain, 0.1° Differential Phase, with A _V = 2 and R _L = 150 Ω , 9.5mA Max Supply Current per Op Amp, ±2V to ±15V Supply Range
LT1360/LT1361/LT1362	Single/Dual/Quad 50MHz, 800V/µs, C-Load™ Op Amps	$\begin{array}{l} \mbox{Fast Settling Voltage Feedback Amplifier, 60ns Settling Time to 0.1\%, \\ 10V Step, 5mA Max Supply Current per Op Amp, 9nV \sqrt{Hz} Input Noise \\ Voltage, Drives All Capacitive Loads, 1mV Max V_{OS}, 0.2\% Differential \\ Gain, 0.3^{\circ} Differential Phase with A_V = 2 \ and R_L = 150\Omega \end{array}$

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